1.6X0.8mm SMD CHIP LED LAMP

Part Number: KPT-1608SGC Super B

Super Bright Green

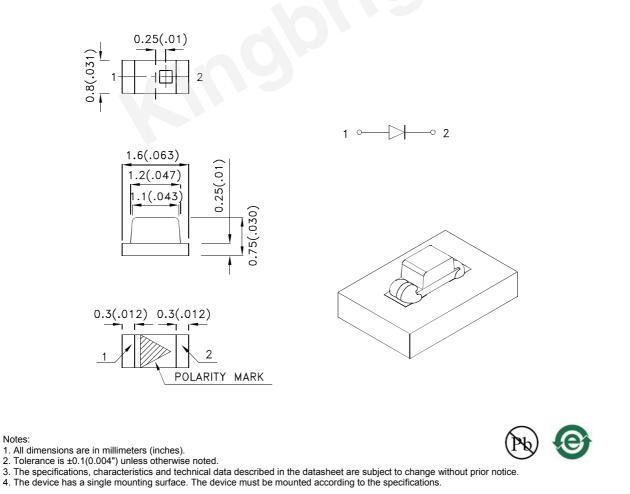
Features

- 1.6mmX0.8mm SMT LED, 0.75mm thickness.
- Low power consumption.
- Wide viewing angle.
- Ideal for backlight and indicator.
- Package: 2000pcs / reel .
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

The Super Bright Green source color devices are made with Gallium Phosphide Green Light Emitting Diode.

Package Dimensions



SPEC NO: DSAA5147 APPROVED: WYNEC REV NO: V.25B CHECKED: Allen Liu DATE: FEB/21/2014 DRAWN: L.Q.Xie PAGE: 1 OF 5 ERP: 1203001741

Selection Guide

			•	lv (mcd) [2] Viewir @ 20mA Angle	
Part No.	Dice	Lens Type	Min. Typ.		201/2
KPT-1608SGC	Super Bright Green (GaP)	Water Clear	5	12	120°

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Luminous intensity/ luminous Flux: +/-15%.

3. Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Super Bright Green	565		nm	I⊧=20mA
λD [1]	Dominant Wavelength	Super Bright Green	568		nm	I⊧=20mA
Δλ1/2	Spectral Line Half-width	Super Bright Green	30		nm	I⊧=20mA
С	Capacitance	Super Bright Green	15		pF	VF=0V;f=1MHz
Vf [2]	Forward Voltage	Super Bright Green	2.2	2.5	V	I⊧=20mA
IR	Reverse Current	Super Bright Green		10	uA	VR=5V

Notes:

1.Wavelength: +/-1nm. 2. Forward Voltage: +/-0.1V.

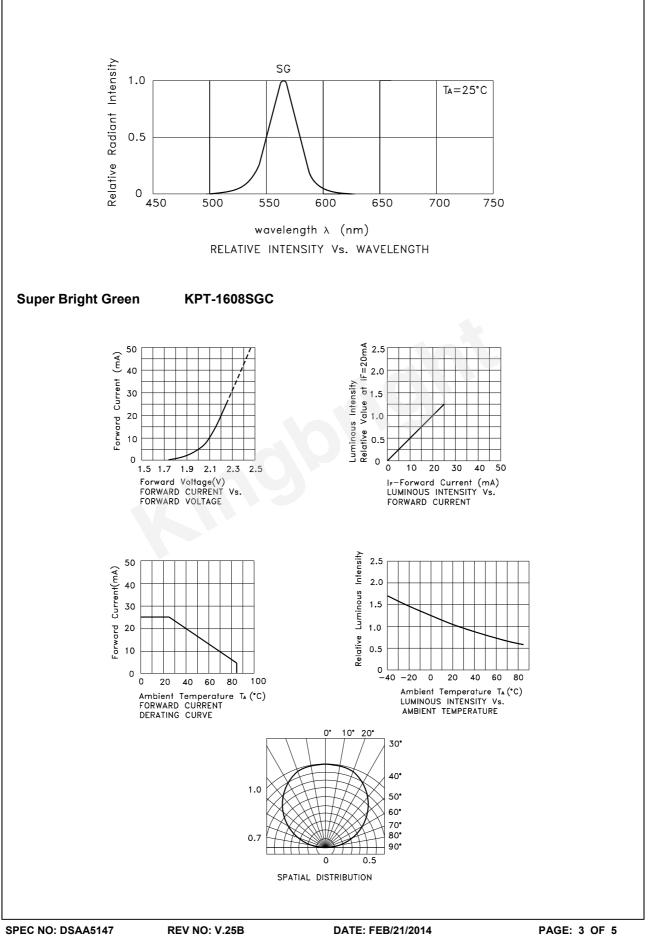
3. Wavelength value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Super Bright Green	Units		
Power dissipation	62.5	mW		
DC Forward Current	25	mA		
Peak Forward Current [1]	140	mA		
Reverse Voltage	5	V		
Operating Temperature	-40°C To +85°C			
Storage Temperature	-40°C To +85°C			

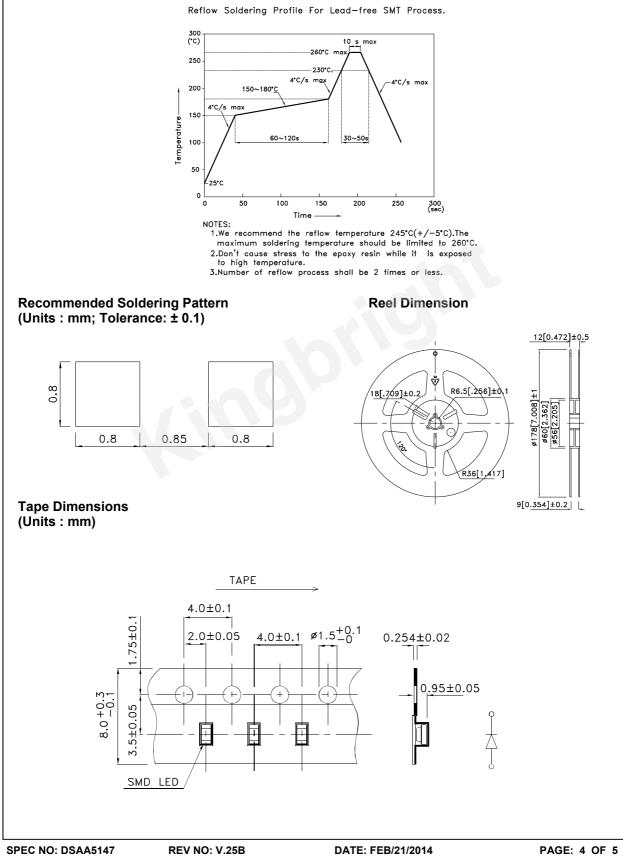
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.

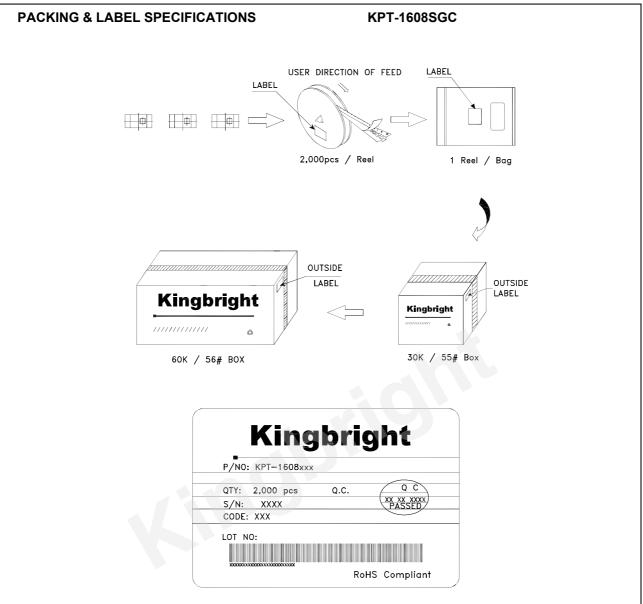


KPT-1608SGC

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.



DATE: FEB/21/2014 DRAWN: L.Q.Xie



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